

My residence, post office address and citizenship are as stated below at 201 et seq. beneath my name.

I believe I am the original, first and sole inventor if only one name is listed at 201 below, or an original, first and joint inventor if plural names are listed at 201 et seq. below, of the subject matter which is claimed and for which a patent is sought on the invention entitled

RESIDIE REMOVERS FOR ELECTROHYDRODYNAMIC CLEANING OF SEMICONDUCTORS

RESIDUE REN	10 ventor career					
and for which a patent application:	:					
☐ is attached hereto and includ	les amendment(s) filed on (if app	plicable)				
was filed in the United State Patent Application Serial No. 10.	s on March 18, 2004 and is ide /802,780	entified by Morgan, I	ewis & Bockius Ll	LP Docket 60937	7-0178-US, and U.S.	
I hereby state that I have reviewed amendment referred to above						
I acknowledge the duty to disclose Regulations,§1.56.	information known to me to b	e material to patentabi	lity as defined in Ti	tle 37, Code of F	ederal	
I hereby claim foreign priority ben certificate listed below and have al of the application on which priority	lso identified below any foreign	ates Code, §119(a)-(d) n application for paten	of any foreign appli t or inventor's certif	ication(s) for pate	nt or inventor's ing date before that	
EARLIEST FOREIGN	N APPLICATION(S), IF ANY	, FILED PRIOR TO T	HE FILING DATE	OF THE APPLI	CATION	
APPLICATION NUMBER	COUNTRY		DATE OF FILING (day, month, year)		PRIORITY CLAIMED	
				YES 🗆	NO 🗆	
				YES 🗆	NO 🗆	
I hereby claim the benefit under Ti	tle 35, United States Code, §1	19(e) of any United Sta	ates provisional app	lication(s) listed	below.	
PROVISIONAL APP		· FILING DATE				
60/455,439	March 18, 20	March 18, 2003				
					•	
I hereby claim the benefit under Ti of each of the claims of this application. 35, United States Code §112, I ack Code of Federal Regulations, §1.56 filing date of this application:	ation is not disclosed in the pri	or United States applice information known to	cation in the manner me which is materia	r provided by the al to patentability	first paragraph of Title as defined in Title 37,	
NON-PROVISIONAL	FILING DATE	STATUS				
APPLICATION SERIAL NO.		PATENTED	PENDI	NG	ABANDONED	
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(1)

for use only when the application is assigned to a company, partnership or other organization.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

	FULL NAME	LAST NAME	FIRST NAME	MIDDLE NAME		
2 0 1	OF INVENTOR	SMALL	Robert	J.		
	RESIDENCE &	стү	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP		
	CITIZENSHIP	Tucson	AZ	United States		
•	POST OFFICE	STREET	CITY	STATE OR COUNTRY	ZIP CODE	
	POST OFFICE ADDRESS	5198 S. Civano Boulevard	Tucson	AZ	85747	
		SIGNATURE OF INVENTOR SMAL	Smelf	June	21, 2004	
	FULL NAME OF INVENTOR	LAST NAME	FIRST NÁME	MODDLE NAME		
2 0 2	RESIDENCE & CITIZENSHIP	спу	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP		
	POST OFFICE ADDRESS	STREET	СПУ	STATE OR COUNTRY	ZIP CODE	
		SIGNATURE OF INVENTOR L		DATE		
2 0 3	FULL NAME OF INVENTOR	LAST NAME	FIRST NAME	MIDDLE NAME		
	RESIDENCE &	СПҮ	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP		
	CITIZENSHIP					
	POST OFFICE ADDRESS	STREET	СПУ	STATE OR COUNTRY	ZIP CODE	
	POST OFFICE	STREET SIGNATURE OF INVENTOR 203	СПУ	STATE OR COUNTRY DATE	ZIP CODE	
	POST OFFICE		FIRST NAME		ZIP CODE	
200	POST OFFICE ADDRESS	SIGNATURE OF INVENTOR 203		DATE		
	POST OFFICE ADDRESS FULL NAME OF INVENTOR RESIDENCE &	SIGNATURE OF INVENTOR 203 LAST NAME	FIRST NAME	DATE MIDDLE NAME		